

**特征 Features**

- 玻璃钝化芯片 Glass passivated chip
- 反向漏电流低 Low reverse leakage
- 正向浪涌承受能力较强 High forward surge capability
- 高温焊接保证 High temperature soldering guaranteed:
260°C/10 秒, 0.375" (9.5mm) 引线长度。
260°C/10 seconds, 0.375" (9.5mm) lead length,
- 引线可承受5 磅 (2.3kg) 拉力。 5 lbs. (2.3kg) tension
- 引线 and 管体皆符合RoHS标准。
Lead and body according with RoHS standard

机械数据 Mechanical Data

- 端子: 镀锡轴向引线 Terminals: Plated axial leads
- 极性: 色环端为负极 Polarity: Color band denotes cathode end
- 安装位置: 任意 Mounting Position: Any

极限值和温度特性 TA = 25°C 除非另有规定。

Maximum Ratings & Thermal Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

	符号 Symbols	HER 251G	HER 252G	HER 253G	HER 254G	HER 255G	HER 256G	HER 257G	HER 258G	单位 Unit
最大可重复峰值反向电压 Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	300	400	600	800	1000	V
最大均方根电压 Maximum RMS voltage	V_{RMS}	35	70	140	210	280	420	560	700	V
最大直流阻断电压 Maximum DC blocking voltage	V_{DC}	50	100	200	300	400	600	800	1000	V
最大正向平均整流电流 Maximum average forward rectified current	$I_{F(AV)}$	2.5								A
峰值正向浪涌电流 8.3ms 单一正弦半波 Peak forward surge current 8.3 ms single half sine-wave	I_{FSM}	80								A
典型热阻 Typical thermal resistance	$R_{\theta JA}$	15								°C/W
工作结温和存储温度 Operating junction and storage temperature range	T_j, T_{STG}	-55 --- +150								°C

电特性 TA = 25°C 除非另有规定。

Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

	符号 Symbols	HER 251G	HER 252G	HER 253G	HER 254G	HER 255G	HER 256G	HER 257G	HER 258G	单位 Unit	
最大正向电压 Maximum forward voltage	$I_F = 2.5A$ V_F	1.0			1.3		1.7			V	
最大反向电流 Maximum reverse current	TA= 25°C TA=125°C I_R	5.0				200					μA
最大反向恢复时间 MAX. Reverse Recovery Time	$I_F=0.5A$ $I_R=1.0A$ $I_{RR}=0.25A$ t_{rr}	50					75				nS
典型结电容 Type junction capacitance	$V_R = 4.0V, f = 1MHz$ C_j	80					50				pF

特性曲线 Characteristic Curves

